Designer's™ Data Sheet

Insulated Gate Bipolar Transistor with Anti-Parallel Diode

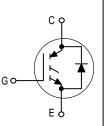
This Insulated Gate Bipolar Transistor (IGBT) is co-packaged with a soft recovery ultra-fast rectifier and uses an advanced termination scheme to provide an enhanced and reliable high voltage-blocking capability. Short circuit rated IGBT's are specifically suited for applications requiring a guaranteed short circuit withstand time such as Motor Control Drives. Fast switching characteristics result in efficient operation at high frequencies. Co-packaged IGBT's save space, reduce assembly time and cost.

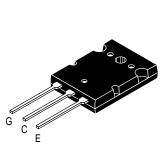
- Industry Standard High Power TO–264 Package (TO–3PBL)
- High Speed Eoff: 160 µJ per Amp typical at 125°C
- High Short Circuit Capability 10 μs minimum
- · Soft Recovery Free Wheeling Diode is included in the package
- Robust High Voltage Termination
- Robust RBSOA

MGY20N120D

Motorola Preferred Device

IGBT & DIODE IN TO-264 20 A @ 90°C 28 A @ 25°C 1200 VOLTS SHORT CIRCUIT RATED





CASE 340G-02, Style 5 TO-264

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	VCES	1200	Vdc
Collector–Gate Voltage (R _{GE} = 1.0 MΩ)	VCGR	1200	Vdc
Gate-Emitter Voltage — Continuous	V _{GE}	±20	Vdc
Collector Current— Continuous @ $T_C = 25^{\circ}C$ — Continuous @ $T_C = 90^{\circ}C$ — Repetitive Pulsed Current (1)	IC25 IC90 IСМ	28 20 56	Adc Apk
Total Power Dissipation @ T _C = 25°C Derate above 25°C	PD	174 1.39	Watts W/°C
Operating and Storage Junction Temperature Range	TJ, Tstg	-55 to 150	°C
Short Circuit Withstand Time (V _{CC} = 720 Vdc, V _{GE} = 15 Vdc, T _J = 125°C, R _G = 20 Ω)	t _{sc}	10	μs
Thermal Resistance — Junction to Case – IGBT — Junction to Case – Diode — Junction to Ambient	R _θ JC R _θ JC R _θ JA	0.7 1.1 35	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	TL	260	°C
Mounting Torque, 6–32 or M3 screw	10 lbf•in (1.13 N•m)		

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

(1) Pulse width is limited by maximum junction temperature. Repetitive rating.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.



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ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

C	haracteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector-to-Emitter Breakdown (V _{GE} = 0 Vdc, I _C = 25 μ Adc)	0	BVCES	1200	_	_	Vdc
Temperature Coefficient (Posit	ve)		-	870	—	mV/°C
Zero Gate Voltage Collector Current ($V_{CE} = 1200 \text{ Vdc}, V_{GE} = 0 \text{ Vdc}$) ($V_{CE} = 1200 \text{ Vdc}, V_{GE} = 0 \text{ Vdc}, T_J = 125^{\circ}C$)		ICES	=		100 2500	μAdc
Gate-Body Leakage Current ($V_{GE} = \pm 20$ Vdc, $V_{CE} = 0$ Vdc)		IGES	_	_	250	nAdc
ON CHARACTERISTICS (1)			1	I	1	
Collector-to-Emitter On-State Voltage		V _{CE(on)}				Vdc
$(V_{GE} = 15 \text{ Vdc}, I_{C} = 10 \text{ Adc})$			—	3.00	3.54	
(V _{GE} = 15 Vdc, I _C = 10 Adc, T _J = 125°C) (V _{GE} = 15 Vdc, I _C = 20 Adc)			_	2.36 2.90	4.99	
Gate Threshold Voltage		V _{GE(th)}				Vdc
$(V_{CE} = V_{GE}, I_C = 1.0 \text{ mAdc})$		VGE(III)	4.0	6.0	8.0	Vuo
Threshold Temperature Coeffic	ient (Negative)		—	10	—	mV/°C
Forward Transconductance (VCE	= 10 Vdc, I _C = 20 Adc)	9fe	—	12	—	Mhos
DYNAMIC CHARACTERISTICS						
Input Capacitance		C _{ies}	-	1876	—	pF
Output Capacitance	(V _{CE} = 25 Vdc, V _{GE} = 0 Vdc, f = 1.0 MHz)	C _{oes}	—	208	—	-
Transfer Capacitance		C _{res}	—	31	—	
SWITCHING CHARACTERISTICS	6 (1)				-	
Turn–On Delay Time	(V _{CC} = 720 Vdc, I _C = 20 Adc,	^t d(on)	—	88	—	ns
Rise Time	$V_{GE} = 15 \text{ Vdc}, \text{ L} = 300 \mu\text{H}$	tr	—	103	—	
Turn-Off Delay Time	$R_G = 20 \Omega, T_J = 25^{\circ}C)$ Energy losses include "tail"	^t d(off)	—	190	—	
Fall Time		tf	—	284	—	
Turn–Off Switching Loss		Eoff	—	1.65	3.75	mJ
Turn–On Switching Loss		Eon	—	2.42	7.68	
Total Switching Loss		E _{ts}	—	4.07	11.43	
Turn–On Delay Time		^t d(on)	_	83	—	ns
Rise Time		tr	_	107	—	1
Turn–Off Delay Time	$R_{G} = 20 \Omega, T_{J} = 125^{\circ}C)$	^t d(off)	_	216	—	1
Fall Time	Energy losses include "tail"	t _f	_	494	—	1
Turn–Off Switching Loss		Eoff	_	3.19	—	mJ
Turn–On Switching Loss	-	E _{on}	_	4.26	—	1
Total Switching Loss		E _{ts}	- 1	7.45	_	1
Gate Charge		QT	-	63	_	nC
	(V _{CC} = 720 Vdc, I _C = 20 Adc, V _{GE} = 15 Vdc)	Q ₁	_	20	_	1
		Q ₂	—	27	—	1
DIODE CHARACTERISTICS	-					•
Diode Forward Voltage Drop						Vdc
$(I_{EC} = 10 \text{ Adc})$		VFEC	-	2.92	3.59	
$(I_{EC} = 10 \text{ Adc}, T_J = 125^{\circ}\text{C})$ $(I_{EC} = 20 \text{ Adc})$			-	1.73 3.67	4.57	1

(1) Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.

(continued)

ELECTRICAL CHARACTERISTICS — continued ($T_J = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
DIODE CHARACTERISTICS — cont	tinued					
Reverse Recovery Time	(I _F = 20 Adc, V _R = 720 Vdc, dI _F /dt = 150 A/μs)	t _{rr}	-	114	—	ns
		ta	—	74	—	
		t _b	-	40	—	
Reverse Recovery Stored Charge		Q _{RR}	-	0.68	—	μC
Reverse Recovery Time		t _{rr}	-	224	—	ns
	(I _F = 20 Adc, V _R = 720 Vdc,	^t a	-	149	—	
	dI _F /dt = 150 A/µs, T _J = 125°C)	t _b	-	75	—	
Reverse Recovery Stored Charge		Q _{RR}	—	2.40	—	μC
NTERNAL PACKAGE INDUCTANC	E					
Internal Emitter Inductance (Measured from the emitter lead 0	0.25" from package to emitter bond pad)	LE	_	13	_	nH

TYPICAL ELECTRICAL CHARACTERISTICS

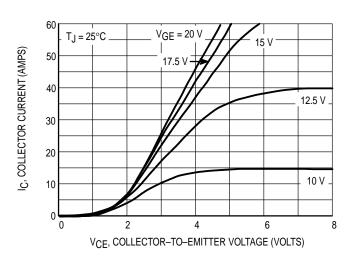


Figure 1. Output Characteristics, T_J = 25°C

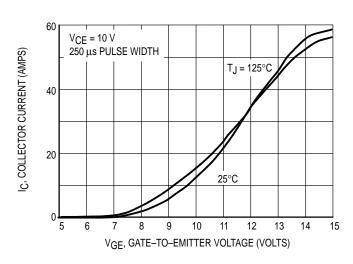


Figure 3. Transfer Characteristics

60 Tj = 125°C V_{GE} = 20 V 15 V . IC, COLLECTOR CURRENT (AMPS) 50 17.5 V 40 12.5 V 30 10 V 20 10 0 0 6 2 4 8 VCE, COLLECTOR-TO-EMITTER VOLTAGE (VOLTS)

Figure 2. Output Characteristics, T_J = 125°C

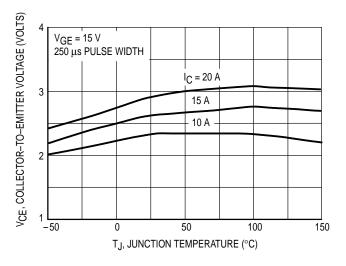


Figure 4. Collector-to-Emitter Saturation Voltage versus Junction Temperature

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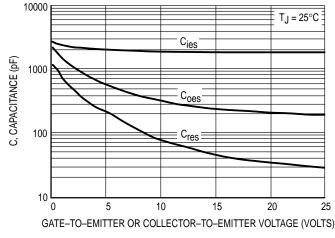


Figure 5. Capacitance Variation

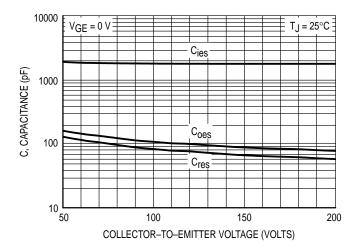


Figure 5b. High Voltage Capacitance Variation

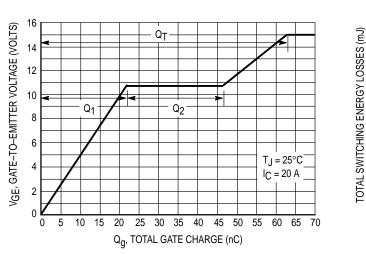
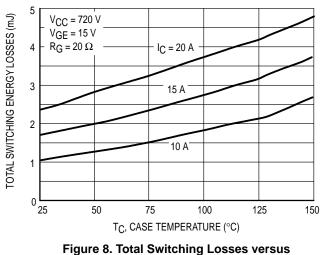


Figure 6. Gate-to-Emitter and Collector-to-Emitter Voltage versus Total Charge



Case Temperature

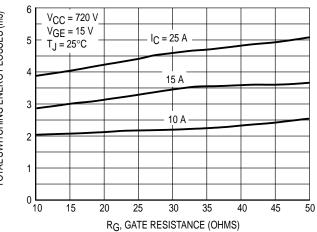


Figure 7. Total Switching Losses versus Gate Resistance

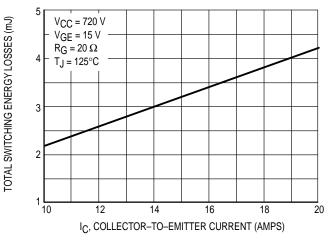


Figure 9. Total Switching Losses versus Collector-to-Emitter Current

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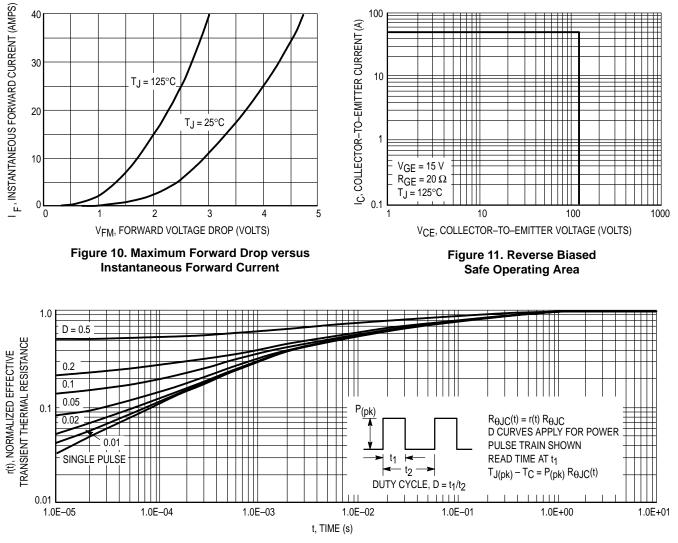
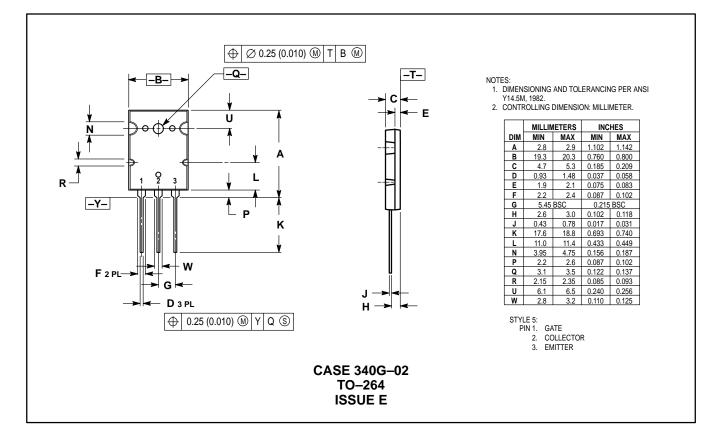


Figure 12. Thermal Response

PACKAGE DIMENSIONS



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How to reach us:

USA/EUROPE/Locations Not Listed: Motorola Literature Distribution; P.O. Box 20912; Phoenix, Arizona 85036. 1–800–441–2447 or 602–303–5454

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MFAX: RMFAX0@email.sps.mot.com - TOUCHTONE 602-244-6609 INTERNET: http://Design-NET.com JAPAN: Nippon Motorola Ltd.; Tatsumi–SPD–JLDC, 6F Seibu–Butsuryu–Center, 3–14–2 Tatsumi Koto–Ku, Tokyo 135, Japan. 03–81–3521–8315

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park, 51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852–26629298



